

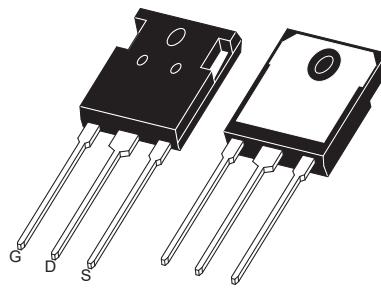
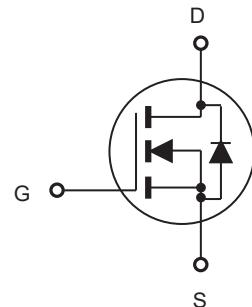


CEW66N60F

N-Channel Super Junction Power MOSFET With Fast Body Diode

FEATURES

- 650V@ $T_{J\max}$, 66A, $R_{DS(ON)} = 44m\Omega$ @ $V_{GS} = 10V$.
- Excellent $R_{DS(ON)}$ and Low Gate Charge.
- Pb-free lead plating ; RoHS compliant.
- Halogen Free.
- Fast reverse recovery time.
- TO-247 package.



TO-247

ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ C$ unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	V_{DS}	600	V
Gate-Source Voltage	V_{GS}	± 30	V
Drain Current-Continuous @ $T_C = 25^\circ C$ @ $T_C = 100^\circ C$	I_D	66 41	A
Drain Current-Pulsed ^a	I_{DM}	264	A
Maximum Power Dissipation @ $T_C = 25^\circ C$ - Derate above 25 $^\circ C$	P_D	480 3.84	W W/ $^\circ C$
Single Pulsed Avalanche Energy ^d	E_{AS}	2254	mJ
Single Pulsed Avalanche Current ^d	I_{AS}	14	A
Operating and Store Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	R_{JC}	0.26	$^\circ C/W$
Thermal Resistance, Junction-to-Ambient	R_{JA}	62.5	$^\circ C/W$



CEW66N60F

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_D = 1\text{mA}$	600			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 600\text{V}, V_{\text{GS}} = 0\text{V}$		10		μA
Gate Body Leakage Current, Forward	I_{GSSF}	$V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
Gate Body Leakage Current, Reverse	I_{GSSR}	$V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$		-100		nA
On Characteristics^b						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$	3		5	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 30\text{A}$		38	44	$\text{m}\Omega$
Gate input resistance	R_g	f=1MHz,open Drain		3.4		Ω
Dynamic Characteristics^c						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 400\text{V}, V_{\text{GS}} = 0\text{V}, f = 400\text{KHz}$		5770		pF
Output Capacitance	C_{oss}			160		pF
Reverse Transfer Capacitance	C_{rss}			30		pF
Switching Characteristics^c						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 300\text{V}, I_D = 20\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 2\Omega$		46		ns
Turn-On Rise Time	t_r			19		ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			122		ns
Turn-Off Fall Time	t_f			12		ns
Total Gate Charge	Q_g	$V_{\text{DS}} = 480\text{V}, I_D = 20\text{A}, V_{\text{GS}} = 10\text{V}$		150		nC
Gate-Source Charge	Q_{gs}			32		nC
Gate-Drain Charge	Q_{gd}			73		nC
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Current	I_S				66	A
Drain-Source Diode Forward Voltage ^b	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_S = 60\text{A}$			1.4	V
Reverse Recovery Time	T_{rr}	$I_F = 60\text{A}, di/dt = 100\text{A/us}$		235		ns
Reverse Recovery Charge	Q_{rr}			2.1		uC
Peak Reverse Recovery Current	I_{rr}			19.5		A

Notes :

a.Repetitive Rating : Pulse width limited by maximum junction temperature.

b.Pulse Test : Pulse Width < 300 μs , Duty Cycle < 2%.

c.Guaranteed by design, not subject to production testing.

d.L = 23mH, $I_{AS} = 14\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$.

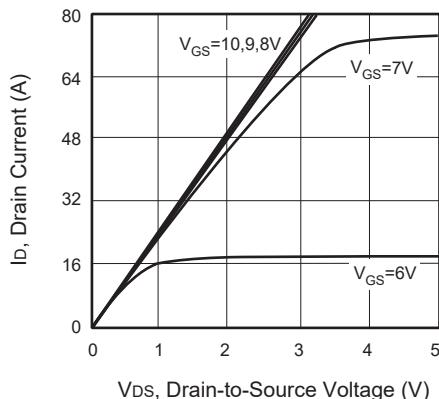


Figure 1. Output Characteristics

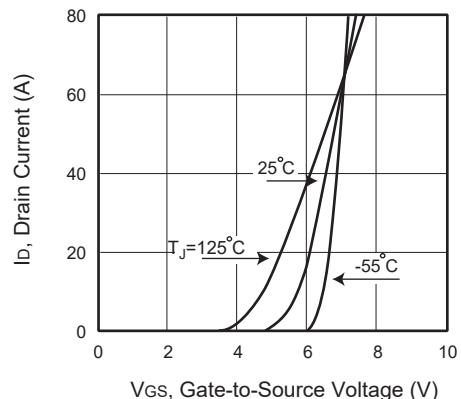


Figure 2. Transfer Characteristics

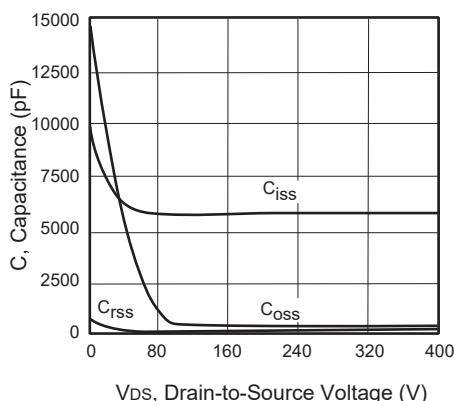


Figure 3. Capacitance

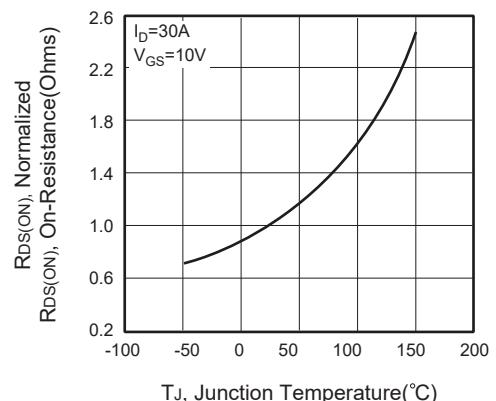


Figure 4. On-Resistance Variation with Temperature

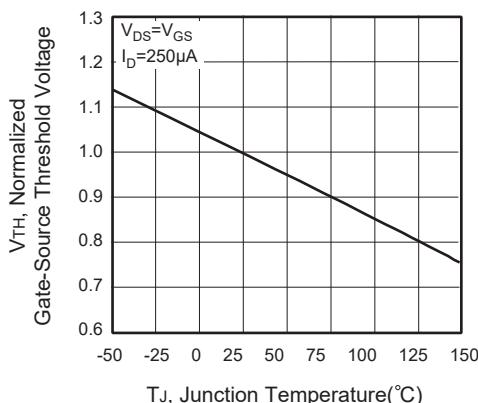


Figure 5. Gate Threshold Variation with Temperature

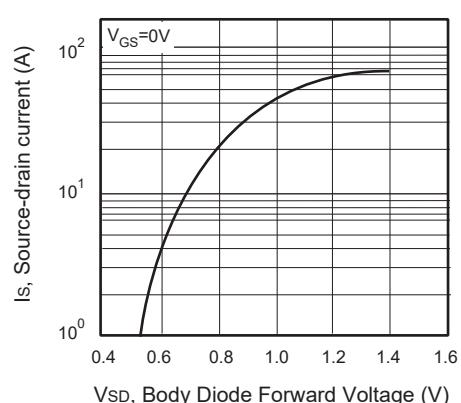


Figure 6. Body Diode Forward Voltage Variation with Source Current

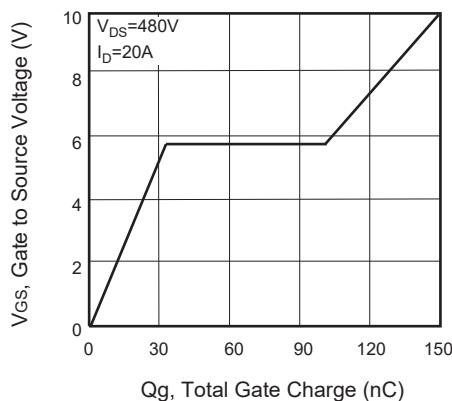


Figure 7. Gate Charge

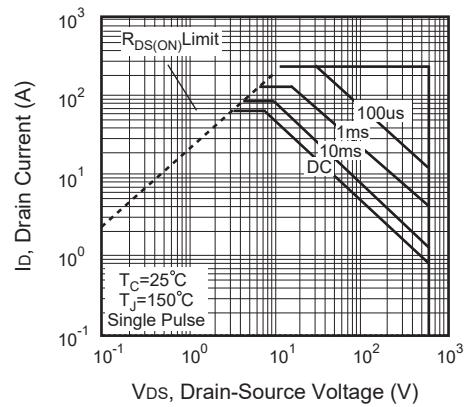


Figure 8. Maximum Safe Operating Area

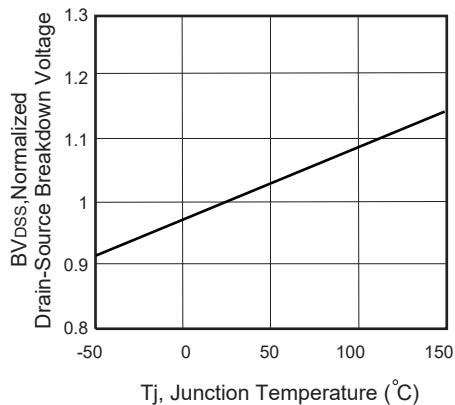


Figure 9. Breakdown Voltage Variation VS Temperature

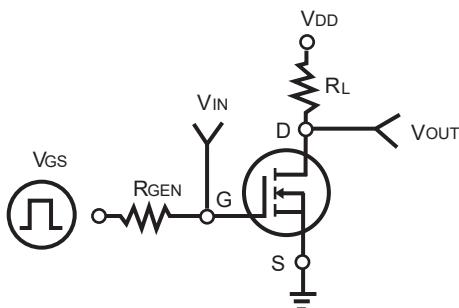


Figure 10. Switching Test Circuit

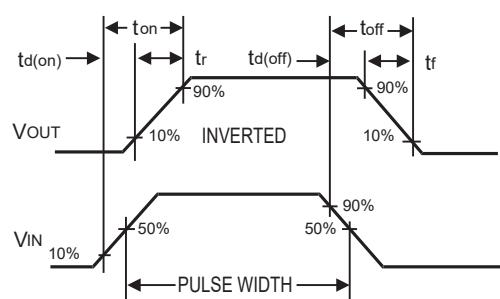


Figure 11. Switching Waveforms

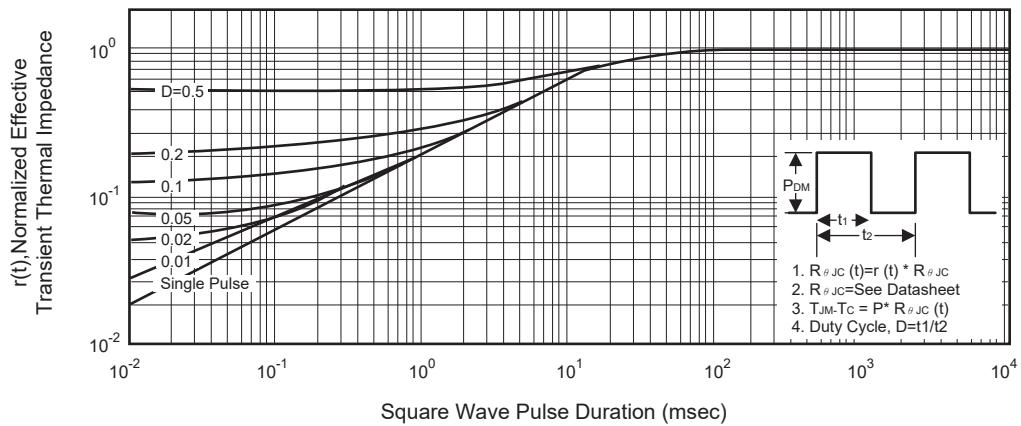
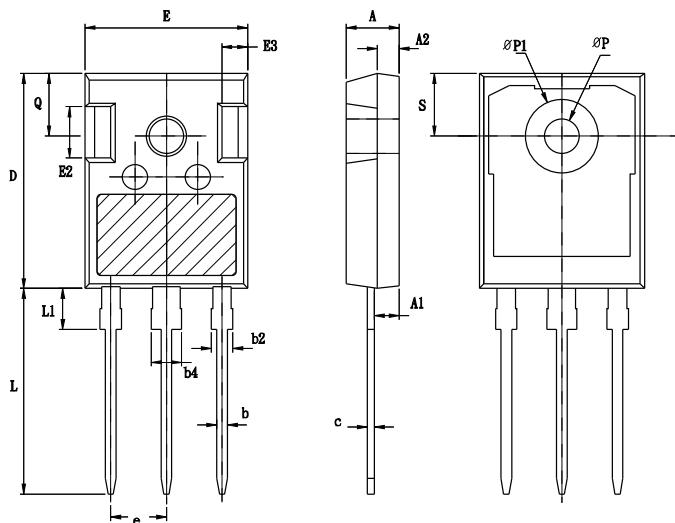


Figure 12. Normalized Thermal Transient Impedance Curve

TO-247 產品外觀尺寸圖 (Product Outline Dimension)



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.830	5.210	0.190	0.205
A1	2.310	2.510	0.091	0.099
A2	1.900	2.160	0.075	0.085
b	1.140	1.400	0.045	0.055
b2	1.910	2.200	0.075	0.087
b4	2.960	3.160	0.117	0.124
C	0.550	0.750	0.022	0.030
D	20.800	21.340	0.819	0.840
e	5.45BSC		0.215BSC	
E	15.700	16.130	0.618	0.635
E2	4.320	5.100	0.170	0.201
E3	1.58	2.60	0.062	0.102
L	19.80	20.57	0.780	0.810
L1	3.81	4.32	0.150	0.170
ΦP	3.5	3.7	0.138	0.146
ΦP1	~	7.3	~	0.287
S	6.15BSC		0.242BSC	
Q	5.59	6.2	0.220	0.244